



**LR Series  
Transmitter Module  
Data Guide**

**Wireless made simple<sup>®</sup>**



**Warning:** Linx radio frequency ("RF") products may be used to control machinery or devices remotely, including machinery or devices that can cause death, bodily injuries, and/or property damage if improperly or inadvertently triggered, particularly in industrial settings or other applications implicating life-safety concerns. No Linx Technologies product is intended for use in any application without redundancies where the safety of life or property is at risk.

The customers and users of devices and machinery controlled with RF products must understand and must use all appropriate safety procedures in connection with the devices, including without limitation, using appropriate safety procedures to prevent inadvertent triggering by the user of the device and using appropriate security codes to prevent triggering of the remote controlled machine or device by users of other remote controllers.

**Do not use this or any Linx product to trigger an action directly from the data line or RSSI lines without a protocol or encoder/decoder to validate the data.**

Without validation, any signal from another unrelated transmitter in the environment received by the module could inadvertently trigger the action. This module does not have data validation built in.

**All RF products are susceptible to RF interference that can prevent communication.**

RF products without frequency agility or hopping implemented are more subject to interference. This module does not have frequency agility built in, but the developer can implement frequency agility with a microcontroller and the example code in Linx Reference Guide RG-00101.

**Do not use any Linx product over the limits in this data guide.**

Excessive voltage or extended operation at the maximum voltage could cause product failure. Exceeding the reflow temperature profile could cause product failure which is not immediately evident.

**Do not make any physical or electrical modifications to any Linx product.**

This will void the warranty and regulatory and UL certifications and may cause product failure which is not immediately evident.

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# LR Series Transmitter Module

## Data Guide



### Description

The LR Series transmitter is ideal for the cost-effective wireless transfer of serial data, control, or command information in the favorable 260–470MHz band. When paired with a compatible Linx receiver, a reliable wireless link is formed, capable of transferring serial data at rates of up to 10,000bps at distances of up to 3,000 feet. Applications operating over shorter distances or at lower data rates will also benefit from increased link reliability and superior noise immunity. The transmitter's synthesized architecture delivers outstanding stability and frequency accuracy and minimizes the affects of antenna pulling. Housed in a tiny reflow-compatible SMD package, the transmitter requires no external RF components except an antenna, which greatly simplifies integration and lowers assembly costs.

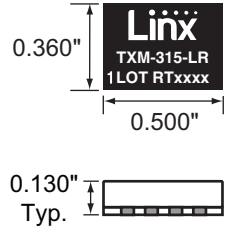


Figure 1: Package Dimensions

### Features

- Long range
- Low cost
- PLL-synthesized architecture
- Direct serial interface
- Data rates up to 10,000bps
- No external RF components required
- Low power consumption
- Low supply voltage (2.1 to 3.6VDC)
- Compact surface-mount package
- Wide temperature range
- Power-down function
- No production tuning

### Applications

- Remote control
- Keyless entry
- Garage/gate openers
- Lighting control
- Medical monitoring/call systems
- Remote industrial monitoring
- Periodic data transfer
- Home/industrial automation
- Fire/security alarms
- Remote status/position sensing
- Long-range RFID
- Wire elimination

## Ordering Information

| Ordering Information |                      |
|----------------------|----------------------|
| Part Number          | Description          |
| TXM-315-LR           | 315MHz Transmitter   |
| TXM-418-LR           | 418MHz Transmitter   |
| TXM-433-LR           | 433MHz Transmitter   |
| RXM-315-LR           | 315MHz Receiver      |
| RXM-418-LR           | 418MHz Receiver      |
| RXM-433-LR           | 433MHz Receiver      |
| EVAL-***-LR          | Basic Evaluation Kit |

\*\*\* = Frequency  
Transceivers are supplied in tubes of 18 pcs.

Figure 2: Ordering Information

## Absolute Maximum Ratings

| Absolute Maximum Ratings |                       |    |                |     |
|--------------------------|-----------------------|----|----------------|-----|
| Supply Voltage $V_{CC}$  | -0.3                  | to | +3.6           | VDC |
| Any Input or Output Pin  | -0.3                  | to | $V_{CC} + 0.3$ | VDC |
| Operating Temperature    | -40                   | to | +85            | °C  |
| Storage Temperature      | -40                   | to | +90            | °C  |
| Soldering Temperature    | +225°C for 10 seconds |    |                |     |

Exceeding any of the limits of this section may lead to permanent damage to the device. Furthermore, extended operation at these maximum ratings may reduce the life of this device.

Figure 3: Absolute Maximum Ratings

## Electrical Specifications

| LR Series Transceiver Specifications |           |               |        |        |             |       |
|--------------------------------------|-----------|---------------|--------|--------|-------------|-------|
| Parameter                            | Symbol    | Min.          | Typ.   | Max.   | Units       | Notes |
| Power Supply                         |           |               |        |        |             |       |
| Operating Voltage                    | $V_{CC}$  | 2.1           | 3.0    | 3.6    | VDC         |       |
| Supply Current                       | $I_{CC}$  |               | 3.4    |        | m           | 1,2   |
| Logic High                           |           |               | 5.1    |        | mA          | 2     |
| Logic Low                            |           |               | 1.8    |        | mA          |       |
| Power Down Current                   | $I_{PDN}$ |               | 5.0    |        | nA          |       |
| Transmitter Section                  |           |               |        |        |             |       |
| Transmit Frequency Range             | $F_C$     |               |        |        |             |       |
| TXM-315-LR                           |           |               | 315    |        | MHz         |       |
| TXM-418-LR                           |           |               | 418    |        | MHz         |       |
| TXM-433-LR                           |           |               | 433.92 |        | MHz         |       |
| Center Frequency Accuracy            |           | -50           |        | +50    | kHz         |       |
| Output Power                         | $P_O$     | -4            | 0.0    | +4     | dBm         | 2     |
| Output Power Control Range           |           | -80           |        | +10    | dB          | 3     |
| Harmonic Emissions                   | $P_H$     |               |        | -36    | dBc         |       |
| Data Rate                            |           | DC            |        | 10,000 | bps         |       |
| Data Input:                          |           |               |        |        |             |       |
| Logic Low                            | $V_{IL}$  |               |        | 0.25   | VDC         |       |
| Logic High                           | $V_{IH}$  | $V_{CC}-0.25$ |        |        | VDC         |       |
| Power Down Input:                    |           |               |        |        |             |       |
| Logic Low                            | $V_{IL}$  |               |        |        | VDC         |       |
| Logic High                           | $V_{IH}$  | $V_{CC}-0.25$ |        |        | VDC         |       |
| Antenna Port                         |           |               |        |        |             |       |
| RF Output Impedance                  | $R_{OUT}$ |               | 50     |        | $\Omega$    | 4     |
| Timing                               |           |               |        |        |             |       |
| Transmitter Turn-On Time             |           |               |        |        |             |       |
| Via $V_{CC}$ or PDN                  |           |               | 1.0    |        | ms          | 4     |
| Modulation Delay                     |           |               |        | 30.0   | nS          | 4     |
| Environmental                        |           |               |        |        |             |       |
| Operating Temperature Range          |           | -40           |        | +85    | $^{\circ}C$ | 4     |

1. With a 50% duty cycle
2. With a 750 $\Omega$  resistor on LADJ
3. See Figure 7 on page 4
4. Characterized, but not tested

Figure 4: Electrical Specifications

## Performance Data

These performance parameters are based on module operation at 25°C from a 3.0VDC supply unless otherwise noted. Figure 2 illustrates the connections necessary for testing and operation. It is recommended all ground pins be connected to the ground plane.

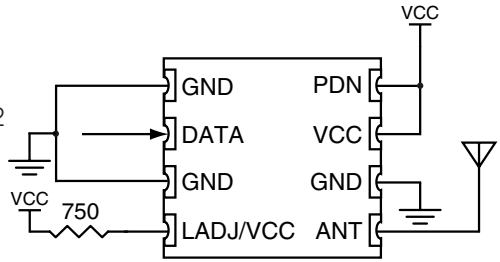


Figure 4: Electrical Specifications

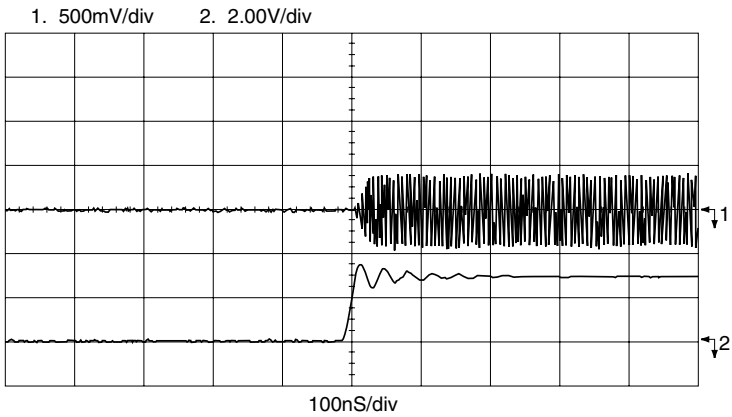


Figure 6: Modulation Delay

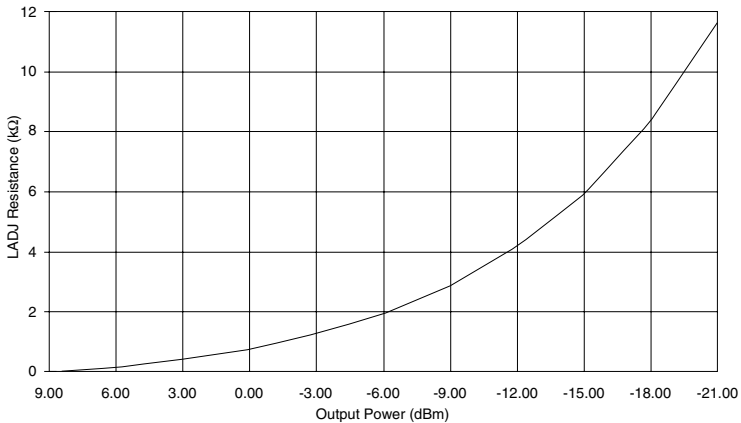


Figure 7: Output Power vs. LADJ Resistance



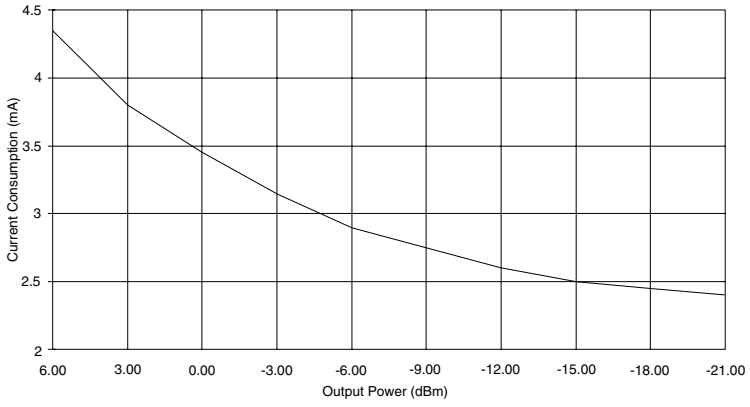


Figure 8: Current Consumption vs. Output Power (50% of Duty Cycle)

## Pin Assignments

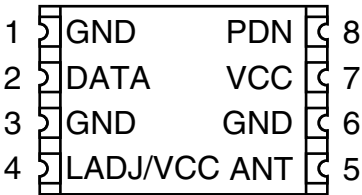


Figure 9: LR Series Transmitter Pinout (Top View)

## Pin Descriptions

| Pin Descriptions |                      |   |
|------------------|----------------------|---|
| Pin Number       | Name                 | Description   |
| 1                | GND                  | Analog Ground   |
| 2                | DATA                 | Digital Data Input  |
| 3                | GND                  | Analog Ground   |
| 4                | LADJ/V <sub>cc</sub> | Level Adjust. This line can be used to adjust the output power level of the transmitter. Connecting to V <sub>cc</sub> will give the highest output, while placing a resistor to V <sub>cc</sub> will lower the output level (see Figure 4 on page 3) |
| 5                | ANT                  | 50Ω RF Output   |
| 6                | GND                  | Analog Ground   |
| 7                | V <sub>cc</sub>      | Supply Voltage  |
| 8                | PDN                  | Power Down. Pulling this line low will place the transmitter into a low-current state. The module will not be able to transmit a signal in this state.  |

Figure 10: Pin Descriptions



**Warning:** This product incorporates numerous static-sensitive components. Always wear an ESD wrist strap and observe proper ESD handling procedures when working with this device. Failure to observe this precaution may result in module damage or failure.

## Module Description

The LR transmitter is a low-cost, high-performance synthesized ASK / OOK transmitter, capable of sending serial data at up to 10,000bps. Because the transmitter is completely self-contained, requiring an antenna as the only additional RF component, application is extremely straightforward and assembly and testing costs are reduced. When combined with an LR Series receiver, a reliable serial link is formed capable of transferring data over line-of-site distances of up to 3,000 feet. The LR is housed in a compact surface-mount package that integrates easily into existing designs and is equally friendly to prototyping and volume production. The module's low power consumption makes it ideal for battery-powered products. The transmitter is compatible with many other Linx receiver products, including the LR, KH2 and OEM product families. For applications where range is critical, the LR receiver is the best choice due to its outstanding sensitivity. LR Series modules are capable of meeting the regulatory requirements of domestic and international applications.

## Theory of Operation

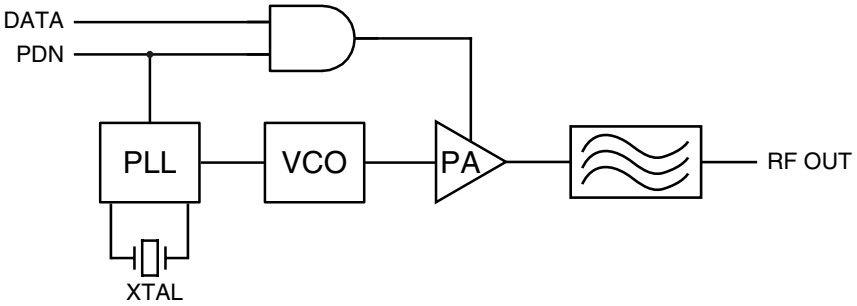


Figure 11: LR Series Transmitter Block Diagram

The LR Series transmitter is designed to generate 1mW of output power into a 50-ohm single-ended antenna while suppressing harmonics and spurious emissions to within legal limits. The transmitter is comprised of a VCO locked by a frequency synthesizer that is referenced to a high precision crystal. The output of the VCO is amplified and buffered by an internal power amplifier. The amplifier is switched by the incoming data to produce a modulated carrier. The carrier is filtered to attenuate harmonics and then output to free space via the 50Ω antenna port.

The synthesized topology makes the module highly immune to the effects of antenna port loading and mismatch. This reduces or eliminates frequency pulling, bit contraction, and other negative effects common to low-cost transmitter architectures. It also allows for reliable performance over a wide operating temperature range. Like its companion LR Series receiver, the LR Series transmitter delivers a significantly higher level of performance and reliability than the LC Series or other SAW-based devices, yet remains very small and cost-effective.

## The Data Input

The CMOS-compatible data input on Pin 2 is normally supplied with a serial bit stream from a microprocessor or encoder, but it can also be used with standard UARTs.

When a logic '1' is present on the DATA line and the PDN line is high, then the Power Amplifier (PA) will be activated and the carrier frequency will be sent to the antenna port. When a logic '0' is present on the DATA line or the PDN line is low, the PA is deactivated and the carrier is fully suppressed.

The DATA line should always be driven with a voltage that is common to the supply voltage present on Pin 7 ( $V_{CC}$ ). The DATA line should never be allowed to exceed the supply voltage, as permanent damage to the module could occur.

## Using the PDN Pin

The transmitter's Power Down (PDN) line can be used to power down the transmitter without the need for an external switch. It allows easy control of the transmitter's state from external components, such as a microcontroller. By periodically activating the transmitter, sending data, then powering down, the transmitter's average current consumption can be greatly reduced, saving power in battery operated applications.

The PDN line does not have an internal pull-up, so it will need to be pulled high or tied directly to VCC to turn on the transmitter. The pull-up should be a minimum of 30 $\mu$ A (10k $\Omega$  or less). When the PDN line is pulled to ground, the transmitter will enter into a low-current (<5nA) power-down mode. When in this mode, the transmitter will be completely off and cannot perform any function.

**Note:** The voltage on the PDN line should not exceed  $V_{CC}$ . When used with a higher voltage source, such as a 5V microcontroller, an open collector line should be used or a diode placed in series with the control line (anode toward the module). Either method avoids damage to the module by preventing 5V from being placed on the PDN line while allowing the line to be pulled low.

## Using LADJ

The Level Adjust (LADJ) line allows the transmitter's output power to be easily adjusted for range control, lower power consumption, or to meet legal requirements. This is done by placing a resistor between VCC and LADJ. The value of the resistor determines the output power level. When LADJ is connected to VCC, the output power and current consumption will be at its maximum. Figure 4 on Page 3 shows a graph of the output power vs. LADJ resistance.

This line is very useful during FCC testing to compensate for antenna gain or other product-specific issues that may cause the output power to exceed legal limits. A variable resistor can be temporarily used so that the test lab can precisely adjust the output power to the maximum level allowed by law. The variable resistor's value can be noted and a fixed resistor substituted for final testing. Even in designs where attenuation is not anticipated, it is a good idea to place a resistor pad connected to LADJ and VCC so that it can be used if needed. For more sophisticated designs, LADJ can be also controlled by a DAC or digital potentiometer to allow precise and digitally variable output power control.

## Power Supply Requirements

The module does not have an internal voltage regulator; therefore it requires a clean, well-regulated power source. While it is preferable to power the unit from a battery, it can also be operated from a power supply as long as noise is less than 20mV. Power supply noise can affect the transmitter modulation; therefore, providing a clean power supply for the module should be a high priority during design.

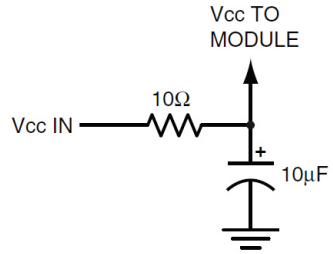


Figure 12: Supply Filter

A 10Ω resistor in series with the supply followed by a 10μF tantalum capacitor from  $V_{CC}$  to ground will help in cases where the quality of the supply is poor. Note that the values may need to be adjusted depending on the noise present on the supply line.

## Transmitting Data

Once a reliable RF link has been established, the challenge becomes how to effectively transfer data across it. While a properly designed RF link provides reliable data transfer under most conditions, there are still distinct differences from a wired link that must be addressed. Since the LR Series modules do not incorporate internal encoding or decoding, a user has tremendous flexibility in how data is handled.

If you want to transfer simple control or status signals, such as button presses or switch closures, and your product does not have a microprocessor on board, or you wish to avoid protocol development, consider using an encoder and decoder IC set. These chips are available from a range of manufacturers, including Linx. They take care of all encoding and decoding functions and generally provide a number of data pins to which switches can be directly connected. In addition, address bits are usually provided for security and to allow the addressing of multiple units independently. These ICs are an excellent way to bring basic remote control / status products to market quickly and inexpensively. Additionally, it is a simple task to interface with inexpensive microprocessors, such as the Microchip PIC, or one of many IR, remote control, or modem ICs.

It is always important to separate what types of transmissions are technically possible from those that are legally allowable in the country of intended operation. While the LR Series is ideally suited to the long range

transfer of control and command information, it can also be used with great success for the transfer of true variable data such as temperature, pressure, or sensor data. However, the 260–470MHz band in which the module operates is regulated by Part 15, Section 231 of the FCC regulations. Many types of transmissions, especially those involving automatic transmissions or variable data, may need to be periodic. You may wish to review Application Notes AN-00125 and AN-00140 along with Part 15, Section 231 of the FCC regulations for further details on acceptable transmission content in the United States.

Another area of consideration is that of data structure or protocol. The data should be formatted in a predictable way and should be able to deal with errors due to interference. This will ensure that the data is received and interpreted correctly. If you are not familiar with the considerations for sending serial data in a wireless environment, you will want to review Application Note AN-00160.

## Protocol Guidelines

While many RF solutions impose data formatting and balancing requirements, Linx RF modules do not encode or packetize the signal content in any manner. The received signal will be affected by such factors as noise, edge jitter, and interference, but it is not purposefully manipulated or altered by the modules. This gives the designer tremendous flexibility for protocol design and interface.

Despite this transparency and ease of use, it must be recognized that there are distinct differences between a wired and a wireless environment. Issues such as interference and contention must be understood and allowed for in the design process. To learn more about protocol considerations, we suggest you read Linx Application Note AN-00160.

Errors from interference or changing signal conditions can cause corruption of the data packet, so it is generally wise to structure the data being sent into small packets. This allows errors to be managed without affecting large amounts of data. A simple checksum or CRC could be used for basic error detection. Once an error is detected, the protocol designer may wish to simply discard the corrupt data or implement a more sophisticated scheme to correct it.



## Interference Considerations

The RF spectrum is crowded and the potential for conflict with other unwanted sources of RF is very real. While all RF products are at risk from interference, its effects can be minimized by better understanding its characteristics.

Interference may come from internal or external sources. The first step is to eliminate interference from noise sources on the board. This means paying careful attention to layout, grounding, filtering, and bypassing in order to eliminate all radiated and conducted interference paths. For many products, this is straightforward; however, products containing components such as switching power supplies, motors, crystals, and other potential sources of noise must be approached with care. Comparing your own design with a Linx evaluation board can help to determine if and at what level design-specific interference is present.

External interference can manifest itself in a variety of ways. Low-level interference will produce noise and hashing on the output and reduce the link's overall range.

High-level interference is caused by nearby products sharing the same frequency or from near-band high-power devices. It can even come from your own products if more than one transmitter is active in the same area. It is important to remember that only one transmitter at a time can occupy a frequency, regardless of the coding of the transmitted signal. This type of interference is less common than those mentioned previously, but in severe cases it can prevent all useful function of the affected device.

Although technically it is not interference, multipath is also a factor to be understood. Multipath is a term used to refer to the signal cancellation effects that occur when RF waves arrive at the receiver in different phase relationships. This effect is a particularly significant factor in interior environments where objects provide many different signal reflection paths. Multipath cancellation results in lowered signal levels at the receiver and, thus, shorter useful distances for the link.

## Typical Applications

Figure 8 shows a circuit using a Linx MS Series encoder. This chip works with the Linx LICAL-DEC-MS001 decoder to provide simple remote control capabilities. The decoder detects the transmission from the encoder, checks for errors, and if everything is correct, replicates the encoder's inputs on its outputs. This makes registering key presses very simple.

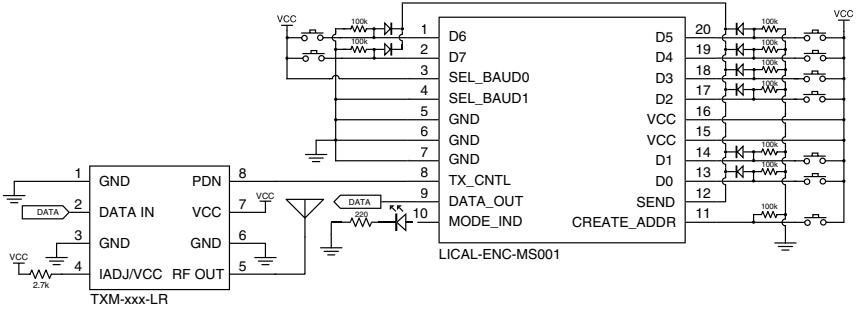


Figure 13: LR Transmitter and MS Encoder

Figure 9 shows a typical RS-232 circuit using the LR transmitter and a Maxim MAX232 chip. The MAX232 converts RS-232 compliant signals from a PC to a serial data stream, which is then transmitted by the LR module.

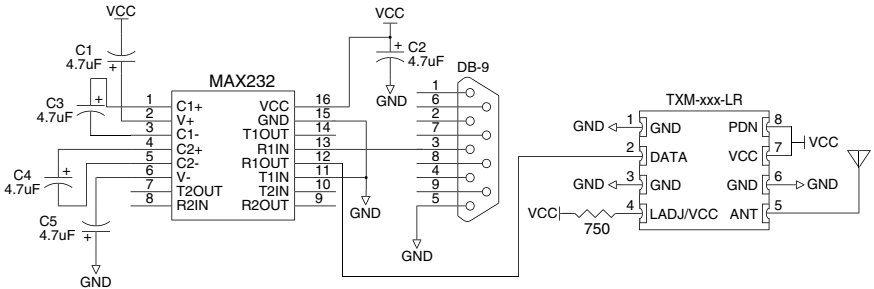


Figure 14: LR Transmitter and MAX232 IC

Figure 10 shows an example of using the LR transmitter with a Linx QS Series USB module. The USB module converts low-speed USB compliant signals from a PC into a serial data stream, which is then transmitted by the LR module.

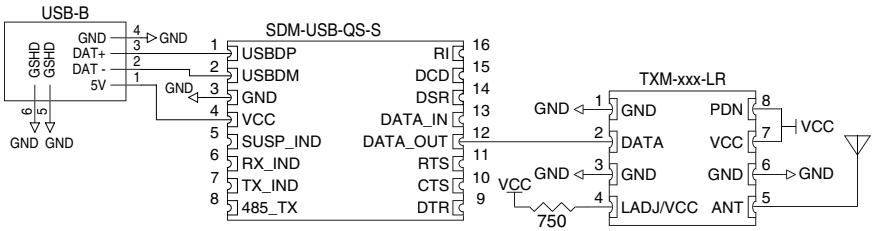


Figure 15: LR Transmitter and Linx QS Series USB Module

## Board Layout Guidelines

If you are at all familiar with RF devices, you may be concerned about specialized board layout requirements. Fortunately, because of the care taken by Linx in designing the modules, integrating them is very straightforward. Despite this ease of application, it is still necessary to maintain respect for the RF stage and exercise appropriate care in layout and application in order to maximize performance and ensure reliable operation. The antenna can also be influenced by layout choices. Please review this data guide in its entirety prior to beginning your design. By adhering to good layout principles and observing some basic design rules, you will be on the path to RF success.

The adjacent figure shows the suggested PCB footprint for the module. The actual pad dimensions are shown in the Pad Layout section of this manual. A ground plane (as large as possible) should be placed on a lower layer of your PCB opposite the module. This ground plane can also be critical to the performance of your antenna, which will be discussed later. There should not be any ground or traces under the module on the same layer as the module, just bare PCB.

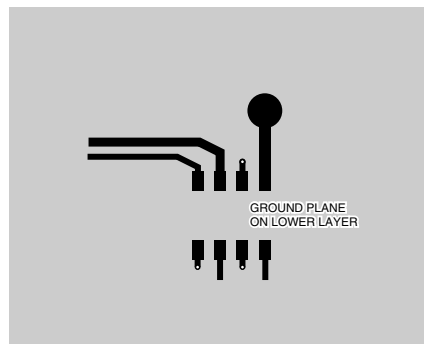


Figure 16: Suggested PCB Layout

During prototyping, the module should be soldered to a properly laid-out circuit board. The use of prototyping or “perf” boards will result in horrible performance and is strongly discouraged.

No conductive items should be placed within 0.15in of the module’s top or sides.

Do not route PCB traces directly under the module. The underside of the module has numerous signal-bearing traces and vias that could short or couple to traces on the product’s circuit board.

The module’s ground lines should each have their own via to the ground plane and be as short as possible.

AM / OOK receivers are particularly subject to noise. The module should, as much as reasonably possible, be isolated from other components on your PCB, especially high-frequency circuitry such as crystal oscillators, switching power supplies, and high-speed bus lines. Make sure internal wiring is routed away from the module and antenna, and is secured to prevent displacement.

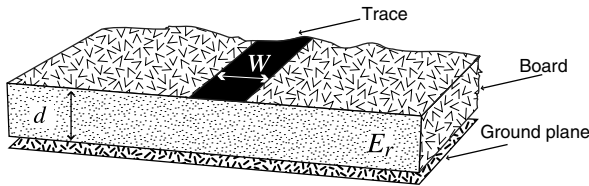
The power supply filter should be placed close to the module’s  $V_{CC}$  line.

In some instances, a designer may wish to encapsulate or “pot” the product. Many Linx customers have done this successfully; however, there are a wide variety of potting compounds with varying dielectric properties. Since such compounds can considerably impact RF performance, it is the responsibility of the designer to carefully evaluate and qualify the impact and suitability of such materials.

The trace from the module to the antenna should be kept as short as possible. A simple trace is suitable for runs up to 1/8-inch for antennas with wide bandwidth characteristics. For longer runs or to avoid detuning narrow bandwidth antennas, such as a helical, use a 50 $\Omega$  coax or 50 $\Omega$  microstrip transmission line as described in the following section.

## Microstrip Details

A transmission line is a medium whereby RF energy is transferred from one place to another with minimal loss. This is a critical factor, especially in high-frequency products like Linx RF modules, because the trace leading to the module's antenna can effectively contribute to the length of the antenna, changing its resonant bandwidth. In order to minimize loss and detuning, some form of transmission line between the antenna and the module should be used, unless the antenna can be placed very close (<1/8in.) to the module. One common form of transmission line is a coax cable, another is the microstrip. This term refers to a PCB trace running over a ground plane that is designed to serve as a transmission line between the module and the antenna. The width is based on the desired characteristic impedance of the line, the thickness of the PCB, and the dielectric constant of the board material. For standard 0.062in thick FR-4 board material, the trace width would be 111 mils. The correct trace width can be calculated for other widths and materials using the information below. Handy software for calculating microstrip lines is also available on the Linx website, [www.linxtechnologies.com](http://www.linxtechnologies.com).



$$E_e = \frac{E_r + 1}{2} + \frac{E_r - 1}{2} \cdot \frac{1}{\sqrt{1 + 12d/W}}$$

$$Z_0 = \begin{cases} \frac{60}{\sqrt{E_e}} \cdot \ln\left(\frac{8d}{W} + \frac{W}{4d}\right) & \text{For } \frac{W}{d} \leq 1 \\ \frac{120\pi}{\sqrt{E_e} \cdot \left(\frac{W}{d} + 1.393 + 0.667 \cdot \ln\left(\frac{W}{d} + 1.444\right)\right)} & \text{For } \frac{W}{d} \geq 1 \end{cases}$$

$E_r$  = Dielectric constant of PCB material

Figure 17: Microstrip Formulas

| Example Microstrip Calculations |                          |                               |                                       |
|---------------------------------|--------------------------|-------------------------------|---------------------------------------|
| Dielectric Constant             | Width/Height Ratio (W/d) | Effective Dielectric Constant | Characteristic Impedance ( $\Omega$ ) |
| 4.80                            | 1.8                      | 3.59                          | 50.0                                  |
| 4.00                            | 2.0                      | 3.07                          | 51.0                                  |
| 2.55                            | 3.0                      | 2.12                          | 48.0                                  |

Figure 18: Example Microstrip Calculations

## Pad Layout

The following pad layout diagram is designed to facilitate both hand and automated assembly.

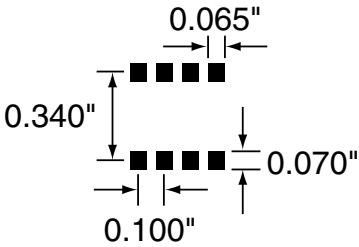


Figure 19: Recommended PCB Layout

## Production Guidelines

The modules are housed in a hybrid SMD package that supports hand or automated assembly techniques. Since the modules contain discrete components internally, the assembly procedures are critical to ensuring the reliable function of the modules. The following procedures should be reviewed with and practiced by all assembly personnel.

## Hand Assembly

Pads located on the bottom of the module are the primary mounting surface. Since these pads are inaccessible during mounting, castellations that run up the side of the module have been provided to facilitate solder wicking to the module's underside. This allows for very quick hand soldering for prototyping and small volume production.

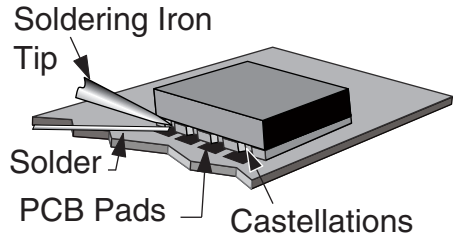


Figure 20: Soldering Technique

If the recommended pad guidelines have been followed, the pads will protrude slightly past the edge of the module. Use a fine soldering tip to heat the board pad and the castellation, then introduce solder to the pad at the module's edge. The solder will wick underneath the module, providing reliable attachment. Tack one module corner first and then work around the device, taking care not to exceed the times listed below.



**Warning:** Pay attention to the absolute maximum solder times.

### Absolute Maximum Solder Times

Hand Solder Temperature TX: +225°C for 10 seconds

Hand Solder Temperature RX: +225°C for 10 seconds

Recommended Solder Melting Point: +180°C

Reflow Oven: +255°C Max. (See Figure 22)

Figure 21: Absolute Maximum Solder Times

## Automated Assembly

For high-volume assembly, most users will want to auto-place the modules. The modules have been designed to maintain compatibility with reflow processing techniques; however, due to their hybrid nature, certain aspects of the assembly process are far more critical than for other component types.

Following are brief discussions of the three primary areas where caution must be observed.

### Reflow Temperature Profile

The single most critical stage in the automated assembly process is the reflow stage. The reflow profile below should not be exceeded, since excessive temperatures or transport times during reflow will irreparably damage the modules. Assembly personnel will need to pay careful attention to the oven's profile to ensure that it meets the requirements necessary to successfully reflow all components while still remaining within the limits mandated by the modules. The figure below shows the recommended reflow oven profile for the modules.

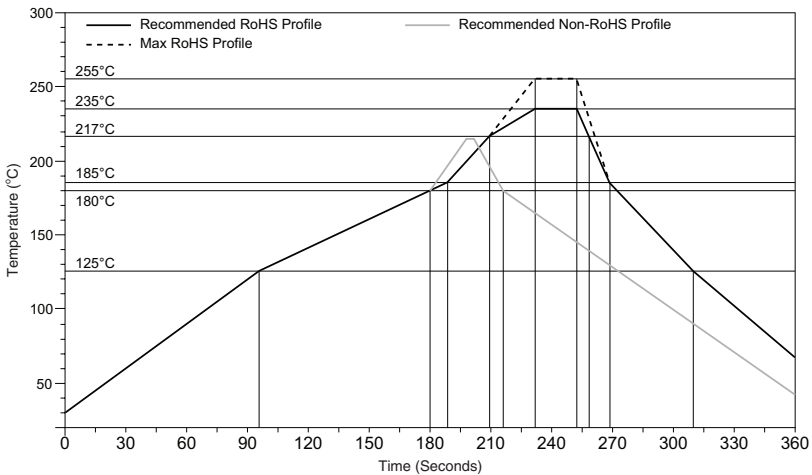


Figure 22: Maximum Reflow Profile



### **Shock During Reflow Transport**

---

Since some internal module components may reflow along with the components placed on the board being assembled, it is imperative that the modules not be subjected to shock or vibration during the time solder is liquid. Should a shock be applied, some internal components could be lifted from their pads, causing the module to not function properly.

### **Washability**

---

The modules are wash resistant, but are not hermetically sealed. Linx recommends wash-free manufacturing; however, the modules can be subjected to a wash cycle provided that a drying time is allowed prior to applying electrical power to the modules. The drying time should be sufficient to allow any moisture that may have migrated into the module to evaporate, thus eliminating the potential for shorting damage during power-up or testing. If the wash contains contaminants, the performance may be adversely affected, even after drying.

## Antenna Considerations

The choice of antennas is a critical and often overlooked design consideration. The range, performance, and legality of an RF link are critically dependent upon the antenna. While adequate antenna performance can often be obtained by trial and error methods, antenna design and matching is a complex task.

A professionally designed antenna, such as those from Linx, will help ensure maximum performance and FCC compliance.



Figure 23: Linx Antennas

Linx transmitter modules typically have an output power that is slightly higher than the legal limits. This allows the designer to use an inefficient antenna, such as a loop trace or helical, to meet size, cost, or cosmetic requirements and still achieve full legal output power for maximum range. If an efficient antenna is used, then some attenuation of the output power will likely be needed. This can easily be accomplished by using the LADJ line or a T-pad attenuator. For more details on T-pad attenuator design, please see Application Note AN-00150.

A receiver antenna should be optimized for the frequency or band in which the receiver operates and to minimize the reception of off-frequency signals. The efficiency of the receiver's antenna is critical to maximizing range performance. Unlike the transmitter antenna, where legal operation may mandate attenuation or a reduction in antenna efficiency, the receiver's antenna should be optimized as much as is practical.

It is usually best to utilize a basic quarter-wave whip until your prototype product is operating satisfactorily. Other antennas can then be evaluated based on the cost, size, and cosmetic requirements of the product. You may wish to review Application Note AN-00500 "Antennas: Design, Application, Performance" and Application Note AN-00501 "Understanding Antenna Specifications and Operation."

## Antenna Sharing

In cases where a transmitter and receiver module are combined to form a transceiver, it is often advantageous to share a single antenna. To accomplish this, an antenna switch must be used to provide isolation between the modules so that the full

transmitter output power is not put on the sensitive front end of the receiver.

There are a wide variety of antenna switches that are cost-effective and easy to use. Among the most popular are switches from Macom and NEC. Look for an antenna switch that has high isolation and low loss at the desired frequency of operation. Generally, the Tx or Rx status of a switch will be controlled by a product's microprocessor, but the user may also make the selection manually. In some cases, where the characteristics of the Tx and Rx antennas need to be different or antenna switch losses are unacceptable, it may be more appropriate to utilize two discrete antennas.

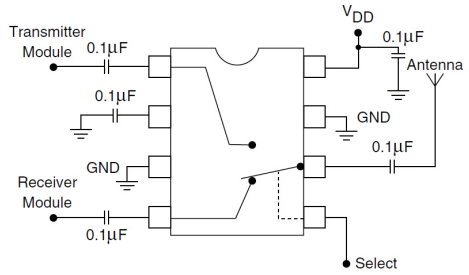


Figure 24: Linx Antennas

## General Antenna Rules

The following general rules should help in maximizing antenna performance.

1. Proximity to objects such as a user's hand, body, or metal objects will cause an antenna to detune. For this reason, the antenna shaft and tip should be positioned as far away from such objects as possible.
2. Optimum performance will be obtained from a quarter or half-wave straight whip mounted at a right angle to the ground plane. In many cases, this isn't desirable for practical or ergonomic reasons, thus, an alternative antenna style such as a helical, loop, or patch may be utilized and the corresponding sacrifice in performance accepted.

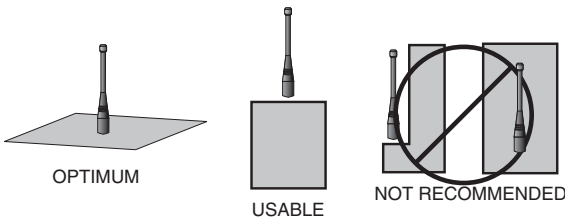


Figure 25: Ground Plane Orientation

3. If an internal antenna is to be used, keep it away from other metal components, particularly large items like transformers, batteries, PCB tracks, and ground planes. In many cases, the space around the antenna is as important as the antenna itself. Objects in close proximity to the antenna can cause direct detuning, while those farther away will alter the antenna's symmetry.
4. In many antenna designs, particularly quarter-wave whips, the ground plane acts as a counterpoise, forming, in essence, a half-wave dipole. For this reason, adequate ground plane area is essential. The ground plane can be a metal case or ground-fill areas on a circuit board. Ideally, it should have a surface area  $>$  the overall length of the half-wave radiating element. This is often not practical due to size and configuration constraints. In these instances, a designer must make the best use of the area available to create as much ground plane

### VERTICAL $\lambda/4$ GROUNDED ANTENNA (MARCONI)

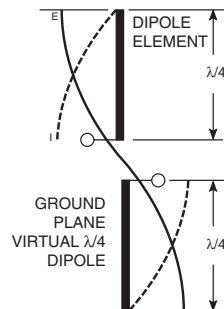


Figure 26: Dipole Antenna

as possible in proximity to the base of the antenna. In cases where the antenna is remotely located or the antenna is not in close proximity to a circuit board, ground plane, or grounded metal case, a metal plate may be used to maximize the antenna's performance.

5. Remove the antenna as far as possible from potential interference sources. Any frequency of sufficient amplitude to enter the receiver's front end will reduce system range and can even prevent reception entirely. Switching power supplies, oscillators, or even relays can also be significant sources of potential interference. The single best weapon against such problems is attention to placement and layout. Filter the module's power supply with a high-frequency bypass capacitor. Place adequate ground plane under potential sources of noise to shunt noise to ground and prevent it from coupling to the RF stage. Shield noisy board areas whenever practical.
6. In some applications, it is advantageous to place the module and antenna away from the main equipment. This can avoid interference problems and allows the antenna to be oriented for optimum performance. Always use 50-ohm coax, like RG-174, for the remote feed.

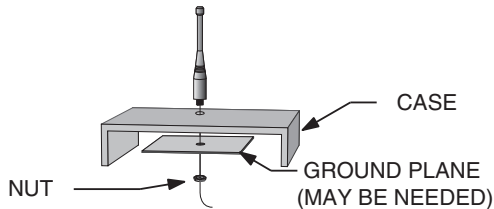


Figure 27: Remote Ground Plane

## Common Antenna Styles

There are literally hundreds of antenna styles and variations that can be employed with Linx RF modules. Following is a brief discussion of the styles most commonly utilized. Additional antenna information can be found in Linx Application Notes AN-00100, AN-00140, AN-00500 and AN-00501. Linx antennas and connectors offer outstanding performance at a low price.

### Whip Style

A whip-style antenna provides outstanding overall performance and stability. A low-cost whip is can be easily fabricated from a wire or rod, but most designers opt for the consistent performance and cosmetic appeal of a professionally-made model. To meet this need, Linx offers a wide variety of straight and reduced-height whip-style antennas in permanent and connectorized mounting styles.



Figure 28: Whip Style Antennas

The wavelength of the operational frequency determines an antenna's overall length. Since a full wavelength is often quite long, a partial half or quarter-wave antenna is normally employed. Its size and natural radiation resistance make it well matched to Linx modules.

The proper length for a straight quarter-wave can be easily determined using the adjacent formula. It is also possible to reduce the overall height of the antenna by using a helical winding. This reduces the antenna's bandwidth, but is a great way to minimize the antenna's physical size for compact applications. This also means that the physical appearance is not always an indicator of the antenna's frequency.

$$L = \frac{234}{F \text{ MHz}}$$

Figure 29:  
L = length in feet of quarter-wave length  
F = operating frequency in megahertz

### Specialty Styles

Linx offers a wide variety of specialized antenna styles. Many of these styles utilize helical elements to reduce the overall antenna size while maintaining reasonable performance. A helical antenna's bandwidth is often quite narrow and the antenna can detune in proximity to other objects, so care must be exercised in layout and placement.



Figure 30: Specialty Style Antennas

## Loop Style

---

A loop- or trace-style antenna is normally printed directly on a product's PCB. This makes it the most cost-effective of antenna styles. The element can be made self-resonant or externally resonated with discrete components, but its actual layout is usually product specific. Despite the cost advantages, loop-style antennas are generally inefficient and useful only for short-range applications. They are also very sensitive to changes in layout and PCB dielectric, which can cause consistency issues during production. In addition, printed styles are difficult to engineer, requiring the use of expensive equipment, including a network analyzer. An improperly designed loop will have a high SWR at the desired frequency, which can cause instability in the RF stage.



Figure 31: Loop or Trace Antenna

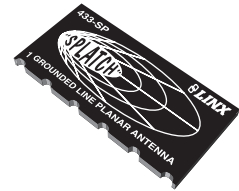


Figure 32: SP Series  
"Splatch" Antenna

Linx offers low-cost planar and chip antennas that mount directly to a product's PCB. These tiny antennas do not require testing and provide excellent performance in light of their small size. They offer a preferable alternative to the often-problematic "printed" antenna.

## Regulatory Considerations

**Note:** Linx RF modules are designed as component devices that require external components to function. The modules are intended to allow for full Part 15 compliance; however, they are not approved by the FCC or any other agency worldwide. The purchaser understands that approvals may be required prior to the sale or operation of the device, and agrees to utilize the component in keeping with all laws governing its use in the country of operation.

When working with RF, a clear distinction must be made between what is technically possible and what is legally acceptable in the country where operation is intended. Many manufacturers have avoided incorporating RF into their products as a result of uncertainty and even fear of the approval and certification process. Here at Linx, our desire is not only to expedite the design process, but also to assist you in achieving a clear idea of what is involved in obtaining the necessary approvals to legally market your completed product.

For information about regulatory approval, read AN-00142 on the Linx website or call Linx. Linx designs products with worldwide regulatory approval in mind.

In the United States, the approval process is actually quite straightforward. The regulations governing RF devices and the enforcement of them are the responsibility of the Federal Communications Commission (FCC). The regulations are contained in Title 47 of the United States Code of Federal Regulations (CFR). Title 47 is made up of numerous volumes; however, all regulations applicable to this module are contained in Volume 0-19. It is strongly recommended that a copy be obtained from the Government Printing Office in Washington or from your local government bookstore. Excerpts of applicable sections are included with Linx evaluation kits or may be obtained from the Linx Technologies website, [www.linxtechnologies.com](http://www.linxtechnologies.com). In brief, these rules require that any device that intentionally radiates RF energy be approved, that is, tested for compliance and issued a unique identification number. This is a relatively painless process. Linx offers full EMC pre-compliance testing in our HP/Emco-equipped test center. Final compliance testing is then performed by one of the many independent testing laboratories across the country. Many labs can also provide other certifications that the product may require at the same time, such as UL, CLASS A/B, etc.



Once your completed product has passed, you will be issued an ID number that is to be clearly placed on each product manufactured.

Questions regarding interpretations of the Part 2 and Part 15 rules or measurement procedures used to test intentional radiators such as Linx RF modules for compliance with the technical standards of Part 15 should be addressed to:

Federal Communications Commission  
Equipment Authorization Division  
Customer Service Branch, MS 1300F2  
7435 Oakland Mills Road  
Columbia, MD, US 21046  
Phone: +1 301 725 585 | Fax: +1 301 344 2050  
Email: [labinfo@fcc.gov](mailto:labinfo@fcc.gov)

ETSI Secretaria  
650, Route des Lucioles  
06921 Sophia-Antipolis Cedex  
FRANCE  
Phone: +33 (0)4 92 94 42 00  
Fax: +33 (0)4 93 65 47 16

International approvals are slightly more complex, although Linx modules are designed to allow all international standards to be met. If you are considering the export of your product abroad, you should contact Linx Technologies to determine the specific suitability of the module to your application.

All Linx modules are designed with the approval process in mind and thus much of the frustration that is typically experienced with a discrete design is eliminated. Approval is still dependent on many factors, such as the choice of antennas, correct use of the frequency selected and physical packaging. While some extra cost and design effort are required to address these issues, the additional usefulness and profitability added to a product by RF makes the effort more than worthwhile.

## Achieving a Successful RF Implementation

Adding an RF stage brings an exciting new dimension to any product. It also means that additional effort and commitment will be needed to bring the product successfully to market. By utilizing pre-made RF modules the design and approval process is greatly simplified. It is still important, however, to have an objective view of the steps necessary to ensure a successful RF integration. Since the capabilities of each customer vary widely, it is difficult to recommend one particular design path, but most projects follow steps similar to those shown in Figure 33.

In reviewing this sample design path, you may notice that Linx offers a variety of services (such as antenna design and FCC pre-qualification) that are unusual for a high-volume component manufacturer. These services, along with an exceptional level of technical support, are offered because we recognize that RF is a complex science requiring the highest caliber of products and support. “Wireless Made Simple” is more than just a motto: it’s our commitment. By choosing Linx as your RF partner and taking advantage of the resources we offer, you will not only survive implementing RF, you may even find the process enjoyable.

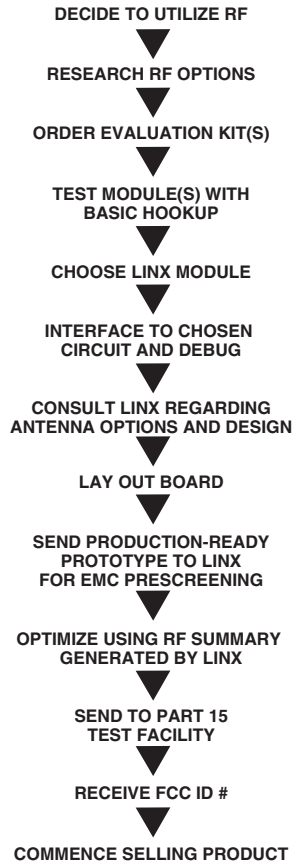


Figure 33: Typical Steps for Implementing RF

## Helpful Application Notes From Linx

It is not the intention of this manual to address in depth many of the issues that should be considered to ensure that the modules function correctly and deliver the maximum possible performance. As you proceed with your design, you may wish to obtain one or more of the following application notes which address in depth key areas of RF design and application of Linx products. These applications notes are available online at [www.linxtechnologies.com](http://www.linxtechnologies.com) or by contacting the Linx literature department.

| <b>Helpful Application Note Titles</b> |  |
|--|--|
| <b>Note Number</b>                     | <b>Note Title</b>  |
| AN-00100                               | RF 101: Information for the RF Challenged                  |
| AN-00125                               | Considerations for Operation Within the 260–470MHz Band    |
| AN-00130                               | Modulation Techniques for Low-Cost RF Data Links           |
| AN-00140                               | The FCC Road: Part 15 from Concept to Approval             |
| AN-00150                               | Use and Design of T-Attenuation Pads                       |
| AN-00160                               | Considerations for Sending Data over a Wireless Link       |
| AN-00232                               | General Considerations for Sending Data with the LC Series |
| AN-00500                               | Antennas: Design, Application and Performance              |

Figure 34: Helpful Application Note Titles



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